

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





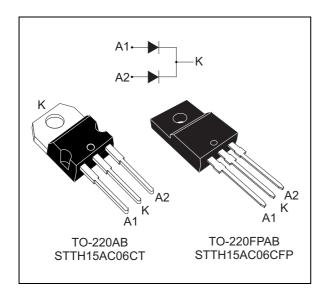


# life.augmented

# STTH15AC06C

# Turbo 2 ultrafast high voltage rectifier

Datasheet - production data



#### **Features**

- · Ultrafast switching
- · Low reverse recovery current
- · Reduces switching and conduction losses
- Low thermal resistance
- insulated package TO-220FPAB:
  - Insulated voltage: 2500  $V_{DC}$

### **Description**

The STTH15AC06C uses ST Turbo 2 600 V technology and is suited as a boost diode in air conditioning equipment for continuous mode interleaved power factor correction.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

**Table 1. Device summary** 

Symbol	Value
I <sub>F(AV)</sub>	2 x 7.5 A
V <sub>RRM</sub>	600 V
t <sub>rr</sub> (max)	25 ns
V <sub>F</sub> (max)	1.5 V
T <sub>j</sub> (max)	175 °C

Characteristics STTH15AC06C

## 1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

Symbol	Parameter		Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage	Repetitive peak reverse voltage				
I <sub>F(RMS)</sub>	Forward rms current	Forward rms current				
	Per diode		7.5	Α		
<sup>I</sup> F(AV)	Average forward current	Average forward current Per device				
I <sub>FSM</sub>	Surge non repetitive forward current	80	Α			
T <sub>stg</sub>	Storage temperature range	-65 to +175	°C			
T <sub>j</sub>	Maximum operating junction temperature	Maximum operating junction temperature				

**Table 3. Thermal parameters** 

Symbol	Parameter	Value	Unit		
	Junction to coop (TO 220AP)	Per diode	2.8		
	Junction to case (TO-220AB)	Total	1.7		
В	Coupling (TO-220AB)	0.6	°C/W		
□th(j-c)	Rth(j-c)	Per diode	6	C/VV	
	Junction to case (TO-220FPAB)	Total	4.5		
	Coupling (TO-220FPAB)	Coupling (TO-220FPAB)			

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V- <b>-</b> V			1	μΑ
'R'	$T_j = 150  ^{\circ}\text{C}$	eakage current $T_j = 150 \text{ °C}$ $V_R = V_{RRM}$		10	100	μΛ	
		T <sub>j</sub> = 25 °C				1.9	
V <sub>E</sub> (2)	Forward voltage drop	T <sub>j</sub> = 150 °C	IF = 7.5A		1.15	1.50	V
<b>v</b> F` ′	VE Poliward voltage drop	T <sub>j</sub> = 25 °C	1 15 0			2.2	V
		T <sub>j</sub> = 150 °C	I <sub>F</sub> = 15A		1.4	1.8	

<sup>1.</sup> Pulse test:  $t_p = 5$  ms,  $\delta < 2\%$ 

To evaluate the conduction losses use the following equation:

$$P = 1.2 \text{ x } I_{F(AV)} + 0.04 I_{F}^{2}_{(RMS)}$$

<sup>2.</sup> Pulse test:  $t_p = 380 \mu s$ ,  $\delta < 2\%$ 

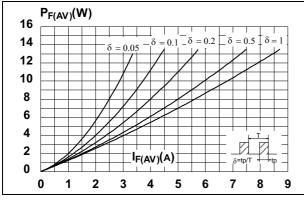
STTH15AC06C Characteristics

Table 5.	Dynamic	characteristics	(per	diode)
i ubic o.	Primiio	Ullul uotoli jotioo	(DCI	alouc,

Symbol	Parameter		Min.	Тур.	Max.	Unit	
t <sub>rr</sub>	Reverse recovery time $T_i = 25^{\circ}$		$I_F = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}, I_{R} = 1 \text{ A}$			25	ns
۲rr	Theverse recovery time	1 <sub>j</sub> = 25 C	$I_F = 1 \text{ A}, V_R = 30 \text{ V}, dI_F/dt = -50 \text{ A}/\mu\text{s}$		35	50	115
I <sub>RM</sub>	Reverse recovery current	T <sub>j</sub> = 125 °C	$I_F = 7.5 \text{ A}, V_R = 400 \text{ V},$ $dI_F/dt = -100 \text{ A}/\mu\text{s}$		3.7	5	Α
t <sub>fr</sub>	Forward recovery time	T <sub>i</sub> = 25 °C	I <sub>F</sub> = 7.5 A, V <sub>FR</sub> = 1.5 V,			100	ns
V <sub>FP</sub>	Forward recovery voltage	1 j = 25 °C	$I_F = 7.5 \text{ A}, V_{FR} = 1.5 \text{ V},$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$		2.5		٧

Figure 1. Average forward power dissipation versus average forward current (per diode)

Figure 2. Forward voltage drop versus forward current (typical values, per diode)



100.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

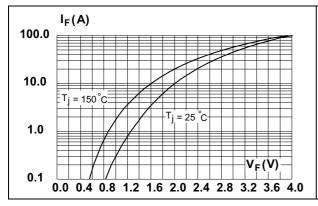
10.0

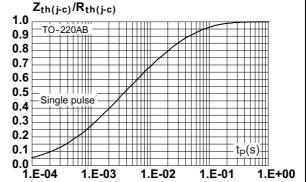
10.0

10.0

Figure 3. Forward voltage drop versus forward current (maximum values, per diode)

Figure 4. Relative variation of thermal impedance, junction to case, versus pulse duration (TO-220AB)





**Characteristics** STTH15AC06C

Figure 5. Relative variation of thermal impedance, junction to case, versus pulse duration (TO-220FPAB)

 $Z_{th(j-c)}/R_{th(j-c)}$ 1.0 0.9 TO-220FPAB 8.0 0.7 0.6 0.5 Single pulse 0.4 0.3 0.2 0.1 t<sub>P</sub>(s)∰ 

Figure 6. Peak reverse recovery versus dI<sub>F</sub>/dt (typical values, per diode)

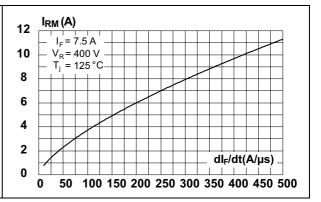


Figure 7. Reverse recovery time versus dI<sub>F</sub>/dt (typical values, per diode)

1.E-02 1.E-01 1.E+00 1.E+01 1.E+02

0.0

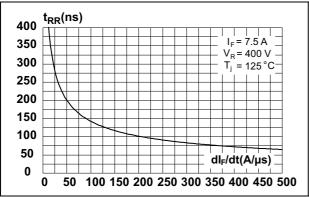


Figure 8. Reverse recovery charges versus dl<sub>F</sub>/dt (typical values, per diode)

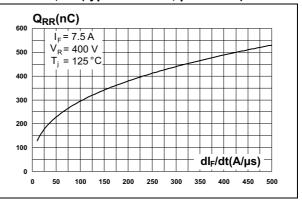


Figure 9. Reverse recovery softness factor versus dl<sub>F</sub>/dt (typical values, per diode)

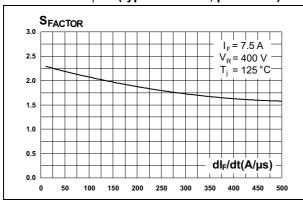
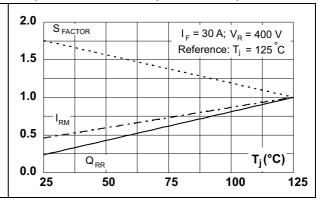


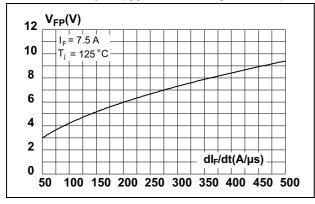
Figure 10. Relative variations of dynamic parameters versus junction temperature



STTH15AC06C Characteristics

Figure 11. Transient peak forward voltage versus dl<sub>F</sub>/dt (typical values, per diode)

Figure 12. Forward recovery time versus dl<sub>F</sub>/dt (typical values, per diode)



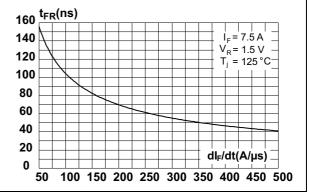
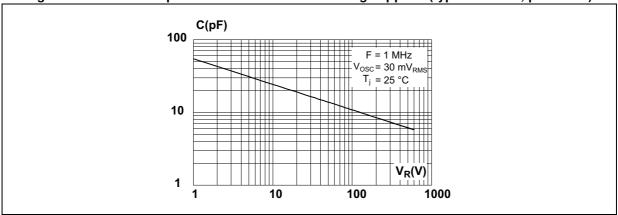


Figure 13. Junction capacitance versus reverse voltage applied (typical values, per diode)



Package information STTH15AC06C

# 2 Package information

• Epoxy meets UL94, V0

• Cooling method: by conduction (C)

Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

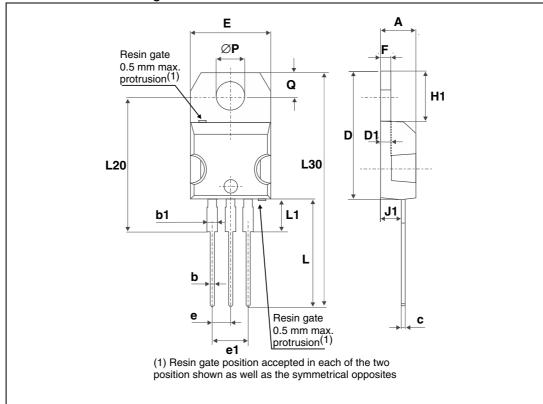


Figure 14. TO220AB dimension definitions

STTH15AC06C Package information

Table 6. TO220AB dimension values

			Dime	ensions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.40		4.60	0.17		0.18
b	0.61		0.88	0.024		0.035
b1	1.14		1.70	0.045		0.067
С	0.48		0.70	0.019		0.027
D	15.25		15.75	0.60		0.62
D1		1.27 typ			0.05 typ.	
E	10		10.40	0.39		0.41
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.19		0.20
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.24		0.26
J1	2.40		2.72	0.094		0.107
L	13		14	0.51		0.55
L1	3.50		3.93	0.137		0.154
L20		16.40 typ			0.64 typ.	
L30		28.90 typ			1.13 typ.	
ØP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116

Package information STTH15AC06C

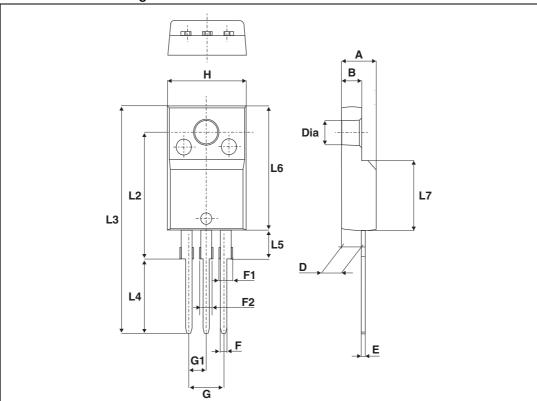


Figure 15. TO220FPAB dimension definitions

Table 7. T0-220FPAB dimension values

			Dime	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
Е	0.45		0.70	0.018		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.70	0.045		0.067
F2	1.15		1.70	0.045		0.067
G	4.95		5.20	0.195		0.205
G1	2.4		2.7	0.094		0.106
Н	10		10.4	0.393		0.409
L2		16 Typ.			0.63 Typ.	
L3	28.6		30.6	1.126		1.205
L4	9.8		10.6	0.386		0.417
L5	2.9		3.6	0.114		0.142
L6	15.9		16.4	0.626		0.646
L7	9.00		9.30	0.354		0.366
Dia.	3.00		3.20	0.118		0.126

Ordering information STTH15AC06C

# 3 Ordering information

**Table 8. Ordering information** 

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH15AC06CT	STTH15AC06CT	TO-220AB	1.9 g	50	Tube
STTH15AC06CFP	STTH15AC06CFP	TO-220FPAB	2.0 g	50	Tube

# 4 Revision history

**Table 9. Document revision history** 

Date	Revision	Changes
21-Oct-2013	1	First release.

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

